

LVDS Interface ICs



56bit LVDS Receiver

8:56 DeSerializer

BU7985KVT**●Description**

LVDS Interface IC of ROHM "Serializer" "Deserializer" operate from 8MHz to 150MHz wide clock range, and number of bits range is from 35 to 70. Data is transmitted seven times (7X) stream and reduce cable number by 3(1/3) or less. The ROHM's LVDS has low swing mode to be able to expect further low EMI.

●Features

- Wide dot clock range : Single(112MHz)/Dual(180MHz)(NTSC, VGA, SVGA, WXGA UXGA)
- Support clock frequency from 20MHz up to 112MHz.
- User programmable LVCMOS data output triggering timing
by using either rising or falling edge of clock.
- User programmable LVCMOS data and clock output driving ability.
- Support Fail-Safe Hi-z Operation.
- 56bit LVDS transmitter is recommended to use BU7988KVT.

●Applications

Flat Panel Display

●Precaution

- This chip is not designed to protect from radioactivity.

Jun.2008

●Block Diagram

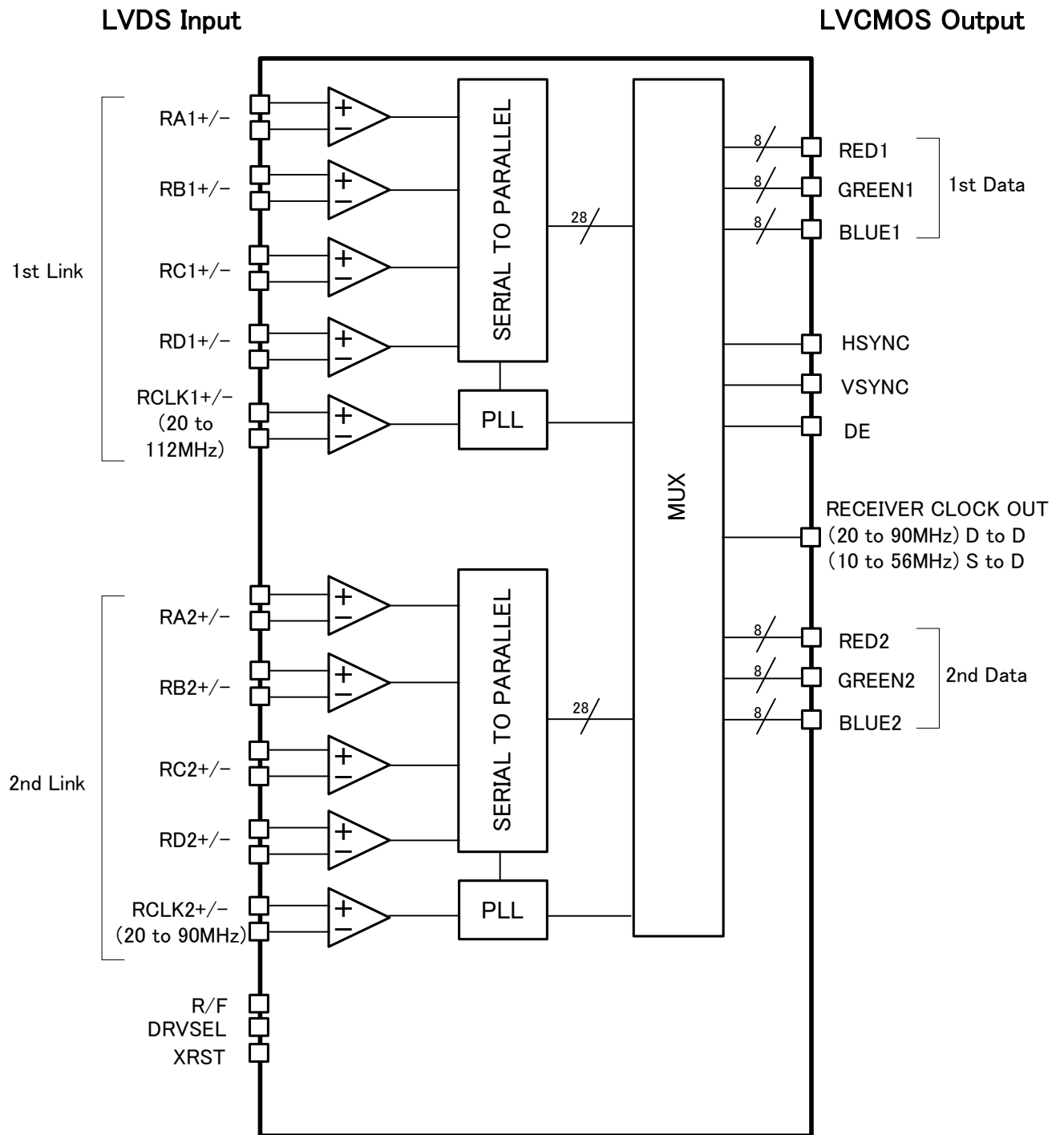


Figure-1 Block Diagram

●TQFP100V Package Outline and Specification

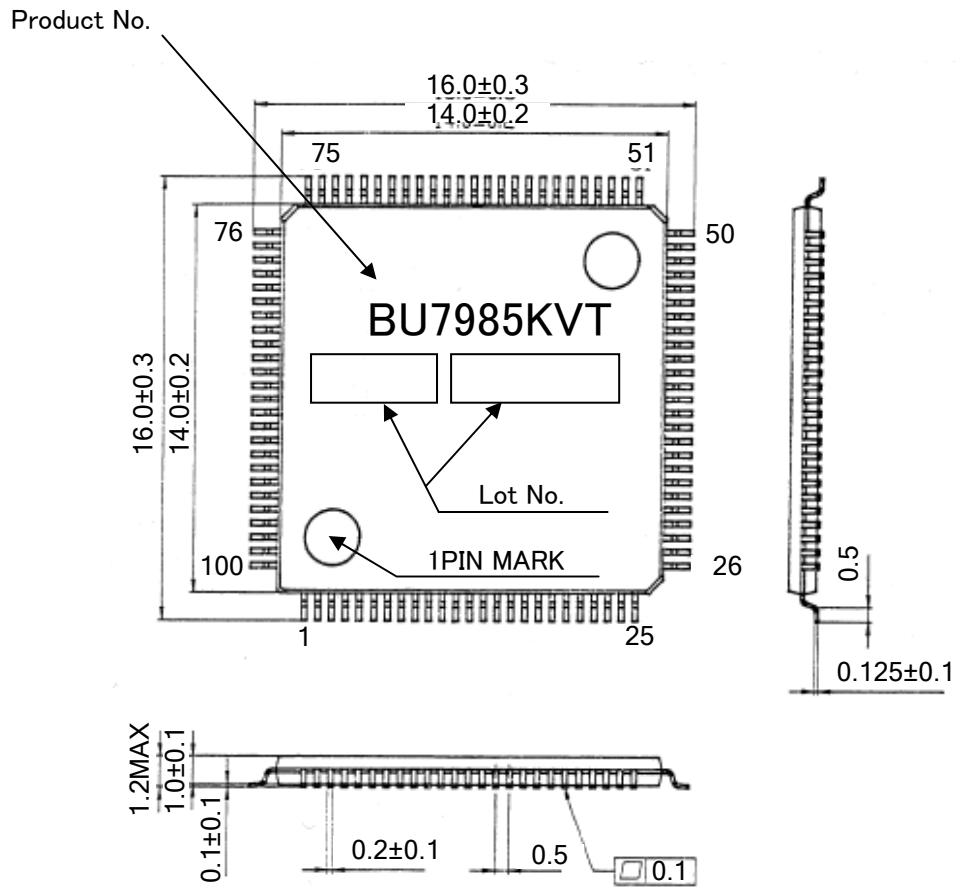


Figure-2 TQFP100V Package Outline and Specification

● Pin configuration

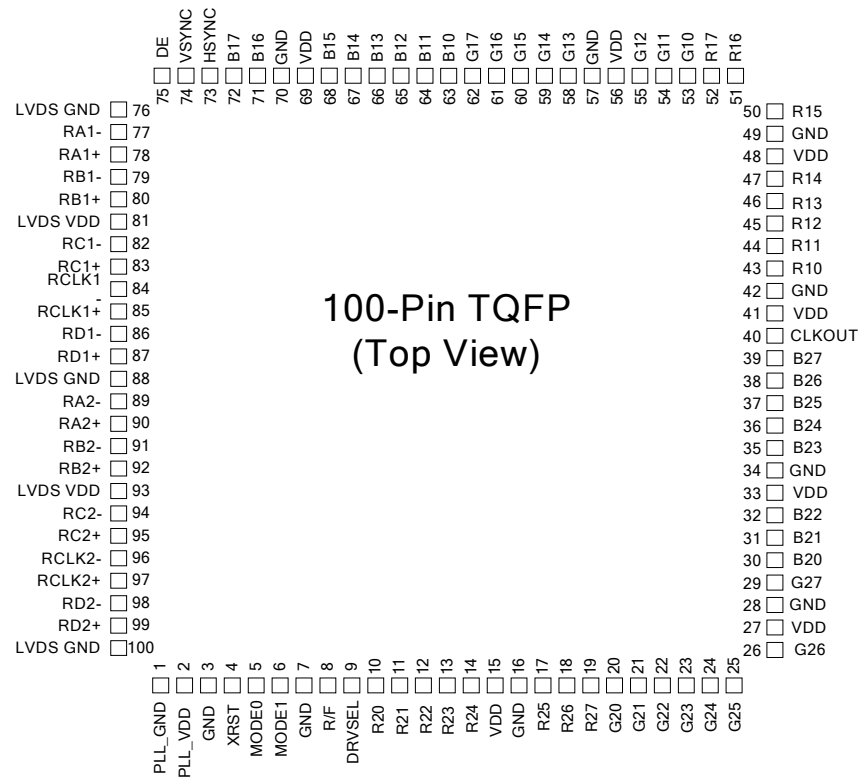


Figure-3 Pin Diagram (Top View)

●Pin Description

Table 1 : Pin Description

Pin Name	Pin No.	Type	Descriptions		
RA1+, RA1-	78, 77	LVDS IN	LVDS Data Input for 1st Link. The 1st pixel input data when Dual Link. + : Positive input of LVDS data differential pair. - : Negative input of LVDS data differential pair.		
RB1+, RB1-	80, 79	LVDS IN			
RC1+, RC1-	83, 82	LVDS IN			
RD1+, RD1-	87, 86	LVDS IN			
RCLK1+, RCLK1-	85, 84	LVDS IN	LVDS Clock Input for 1st Link.		
RA2+, RA2-	90, 89	LVDS IN	LVDS Data Input for 2nd Link. These pins are disabled when Single Link. + : Positive input of LVDS data differential pair. - : Negative input of LVDS data differential pair.		
RB2+, RB2-	92, 91	LVDS IN			
RC2+, RC2-	95, 94	LVDS IN			
RD2+, RD2-	99, 98	LVDS IN			
RCLK2+, RCLK2-	97, 96	LVDS IN	LVDS Clock Input for 2nd Link.		
R17 ~ R10	52, 51, 50, 47, 46, 45, 44, 43	OUT	The 1st Pixel Data Outputs.		
G17 ~ G10	62, 61, 60, 59, 58, 55, 54, 53	OUT			
B17 ~ B10	72, 71, 68, 67, 66, 65, 64, 63	OUT			
R27 ~ R20	19, 18, 17, 14, 13, 12, 11, 10	OUT	The 2nd Pixel Data Outputs.		
G27 ~ G20	29, 26, 25, 24, 23, 22, 21, 20	OUT			
B27 ~ B20	39, 38, 37, 36, 35, 32, 31, 30	OUT			
DE	75	OUT	Data Enable Output.		
VSYNC	74	OUT	Vsync Output.		
HSYNC	73	OUT	Hsync Output.		
CLKOUT	40	OUT	Clock Output.		
DRVSEL	9	IN	Output Driverbility Select. L: Data output 2mA / Clock output 4mA H: Data output 4mA / Clock output 8mA		
R/F	8	IN	Output Clock Triggering Edge Select. H: Rising edge, L: Falling edge.		
MODE1,MODE0	6, 5	IN	Pixel Data Mode.		
			MODE1	MODE0	Mode
			L	L	Dual Link
			L	H	Single Link
			H	L	Dual Link With Fail-Safe Hiz
			H	H	Single Link With Fail-Safe Hiz

Pin Name	Pin No.	Type	Descriptions
XRST	4	IN	H: Normal operation, L: Power down (all outputs are pulled to ground)
VDD	15, 27, 33, 41, 48, 56, 69	Power	Power Supply Pins for LVCMOS outputs and digital circuitry.
GND	3, 7, 16, 28, 34, 42, 49, 57, 70	Ground	Ground Pins for LVCMOS outputs and digital circuitry.
LVDS VDD	81,93	Power	Power Supply Pins for LVDS inputs.
LVDS GND	76, 88, 100	Ground	Ground Pins for LVDS inputs.
PLL VDD	2	Power	Power Supply Pin for PLL circuitry.
PLL GND	1	Ground	Ground Pin for PLL circuitry.

●Electrical characteristics

■Rating

Table 2 : Absolute maximum rating

Item	Symbol	Value		Unit
		Min.	Max.	
Supply voltage	VDD	-0.3	4.0	V
Input voltage	VIN	-0.3	VDD+0.3	V
Output voltage	VOOUT	-0.3	VDD+0.3	V
Storage temperature range	Tstg	-55	125	°C

Table 3 : Package Power

PACKAGE	Power Dissipation (mW)	De-rating (mW/°C)*1
TQFP100V	900	9.0
	1400*2	14.0*2
	2550*2	25.5*2

*1:At temperature Ta >25°C

*2:Package power when mounting on the PCB board.

The size of PCB board :70 × 70 × 1.6 (mm³) / 140 × 150 × 1.6 (mm³)

The material of PCB board : The FR4 glass epoxy board.(3% or less copper foil area)

(It is recommended to apply the above package power requirement to PCB board when the small swing input mode is used)

Table 4 : Recommended Operating Conditions

Parameter	Symbol	Rating			Units	Conditions
		Min	Typ	Max		
Supply Voltage	V _{DD}	3.0	3.3	3.6	V	VDD,LVDSVDD,PLLVD
Operating Temperature Range	T _{opr}	-20	-	85	°C	

■ DC characteristics

Table 5 : LVCMOS DC Specifications (VDD=3.0V~3.6V, Ta=-20°C~+85°C)

Symbol	Parameter	Rating			Units	Conditions
		Min	Typ	Max		
V _{IH}	High Level Input Voltage	V _{DD} × 0.8	–	V _{DD}	V	
V _{IL}	Low Level Input Voltage	GND	–	V _{DD} × 0.2	V	
V _{OH}	High Level Output Voltage	2.4	–	V _{DD}	V	I _{OH} = -2mA, -4mA (data) I _{OH} = -4mA, -8mA (clock)
V _{OL}	Low Level Output Voltage	0.0	–	0.4	V	I _{OL} = 2mA, 4mA (data) I _{OL} = 4mA, 8mA (clock)
I _{INC}	Input Leak Current	-10	–	+10	μ A	0V ≤ V _{IN} ≤ V _{DD}
I _{OZ}	Output Leak Current	-10	–	+10	μ A	Output=Hiz, 0V ≤ V _{OUT} ≤ V _{DD}

Table 6 : LVDS Receiver DC Specifications (VDD=3.0V~3.6V, Ta=-20°C~+85°C)

Symbol	Parameter	Rating			Units	Conditions
		Min	Typ	Max		
V _{TH}	Differential Input High Threshold	–	–	100	mV	V _{OC} =1.2V
V _{TL}	Differential Input Low Threshold	-100	–	–	mV	V _{OC} =1.2V
I _{INL}	Input Current	-20	–	+20	μ A	V _{IN} =2.4V/0V V _{DD} =3.6

■ Supply Current

Table 7 : Supply Current(VDD=3.3V, Ta=25°C)

Symbol	Parameter	Rating			Units	Conditions	
		Min	Typ	Max			
I _{RCCG}	Receiver supply current (Gray scale pattern)	–	88	–	mA	MODE[1:0]=L L, H L CL=8pF	f=90MHz
		–	62	–	mA	MODE[1:0]=L H, H H CL=8pF	f=112MHz
I _{RCCW}	Receiver supply current (Checker pattern)	–	137	–	mA	MODE[1:0]=L L, H L CL=8pF	f=90MHz
		–	89	–	mA	MODE[1:0]=L H, H H CL=8pF	f=112MHz
I _{RCCS}	Receiver Power Down Supply Current	–	–	10	μ A	XRST=L	

256 Gray Scale Pattern

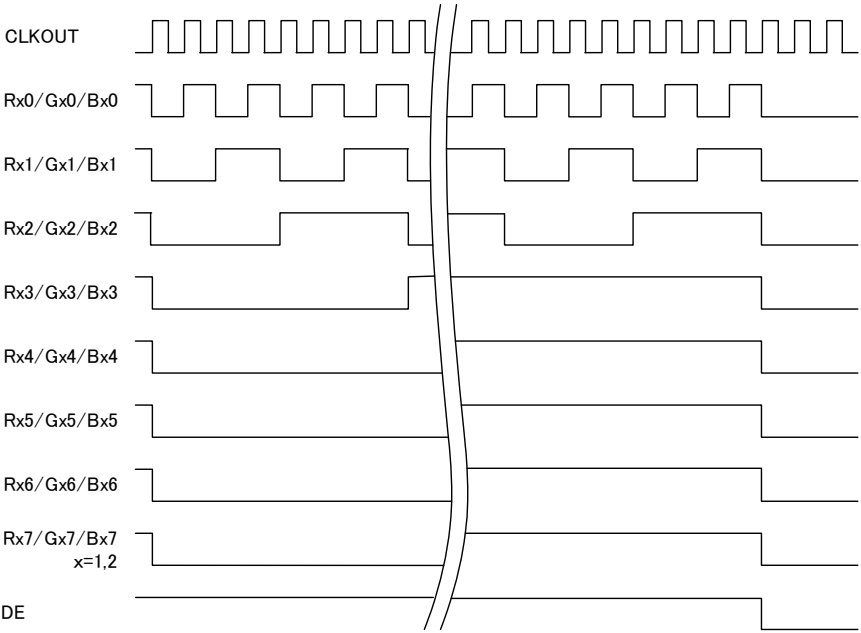


Figure-4 Gray scale pattern

Double Checker Pattern

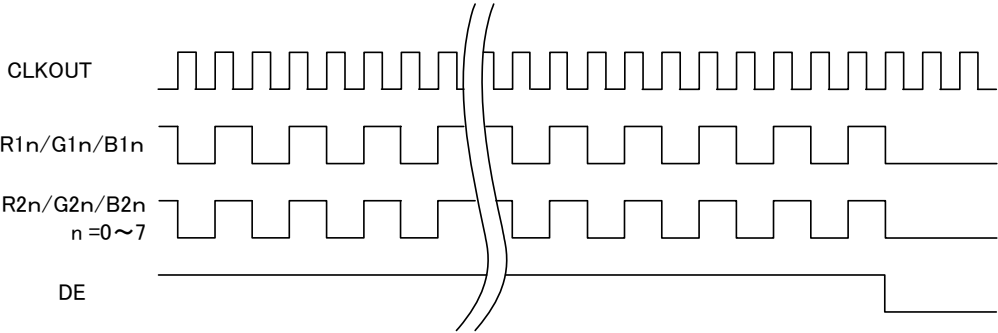


Figure-5 Checker pattern

■ AC characteristics

Table 8 : Switching Characteristics (VDD=3.0V~3.6V, Ta=-20°C~+85°C)

Symbol	Parameter		Min	Typ	Max	Units
t_{RCP}	CLK OUT Period	Dual-in / Dual-out	11.11	t_{RCIP}	50	ns
		Single-in / Dual-out	17.85	$2t_{RCIP}$	100	
t_{RCH}	CLKOUT High Time		—	$0.5t_{RCP}$	—	ns
t_{RCL}	CLKOUT Low Time		—	$0.5t_{RCP}$	—	ns
t_{RS}	LVCMOS Data Setup to CLKOUT		$0.3t_{RCP}$	—	—	ns
t_{RH}	LVCMOS data hold from CLKOUT		$0.3t_{RCP}$	—	—	ns
t_{TLH}	LVCMOS Low to High Transition Time		—	3.0	5.0	ns
t_{THL}	LVCMOS Low to Low Transition Time		—	3.0	5.0	
t_{RIP1}	Input Data Position0 ($T_{RCIP} = 8.9ns$)		-0.25	0.0	+0.25	ns
t_{RIP0}	Input Data Position1 ($T_{RCIP} = 8.9ns$)		$\frac{t_{RCIP}}{7} - 0.25$	$\frac{t_{RCIP}}{7}$	$2\frac{t_{RCIP}}{7} + 0.25$	ns
t_{RIP6}	Input Data Position2 ($T_{RCIP} = 8.9ns$)		$2\frac{t_{RCIP}}{7} - 0.25$	$2\frac{t_{RCIP}}{7}$	$2\frac{t_{RCIP}}{7} + 0.25$	ns
t_{RIP5}	Input Data Position3 ($T_{RCIP} = 8.9ns$)		$3\frac{t_{RCIP}}{7} - 0.25$	$3\frac{t_{RCIP}}{7}$	$3\frac{t_{RCIP}}{7} + 0.25$	ns
t_{RIP4}	Input Data Position4 ($T_{RCIP} = 8.9ns$)		$4\frac{t_{RCIP}}{7} - 0.25$	$4\frac{t_{RCIP}}{7}$	$4\frac{t_{RCIP}}{7} + 0.25$	ns
t_{TOP3}	Input Data Position5 ($T_{RCIP} = 8.9ns$)		$5\frac{t_{RCIP}}{7} - 0.25$	$5\frac{t_{RCIP}}{7}$	$5\frac{t_{RCIP}}{7} + 0.25$	ns
t_{RIP2}	Input Data Position6 ($T_{RCIP} = 8.9ns$)		$6\frac{t_{RCIP}}{7} - 0.25$	$6\frac{t_{RCIP}}{7}$	$6\frac{t_{RCIP}}{7} + 0.25$	ns
t_{RRLl}	Phase Lock Loop Set		—	—	10.0	ms
t_{RCIP}	CLKIN Period		8.9	—	50	ns
t_{ck12}	Skew Time between RCLK1 and RCLK2		—	—	$\pm 0.3t_{RCIP}$	ns

● AC Timing

■ LVCMOS

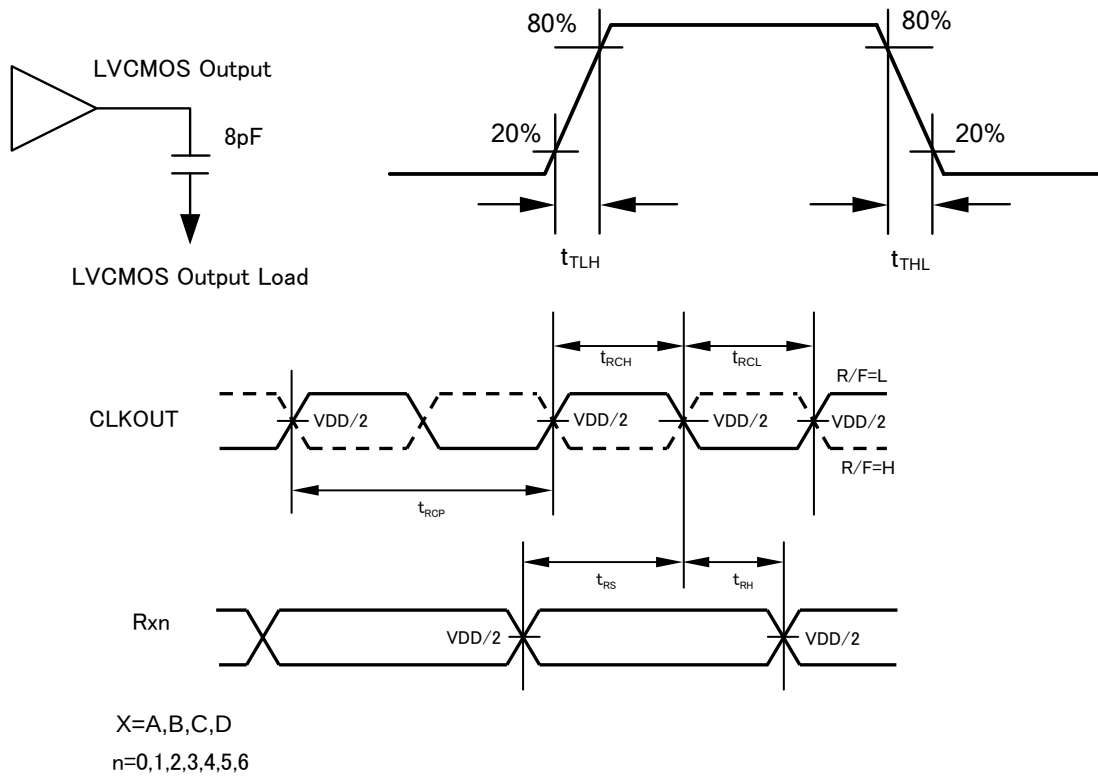


Figure-6 LVCMOS output timing

■ Phase-locked loops set time

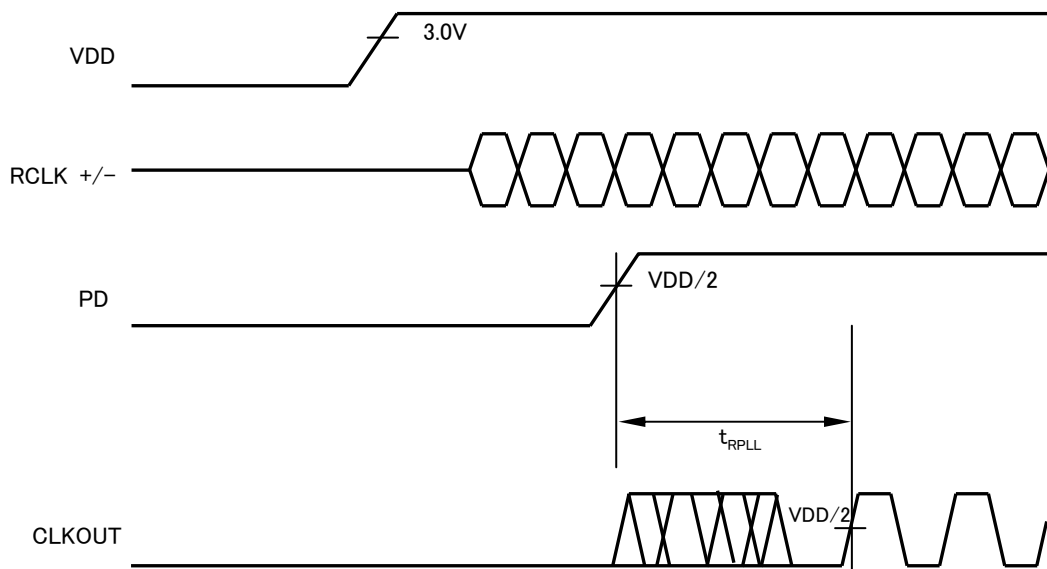


Figure-7 Phase-locked loops set time

■ AC Timing Diagrams

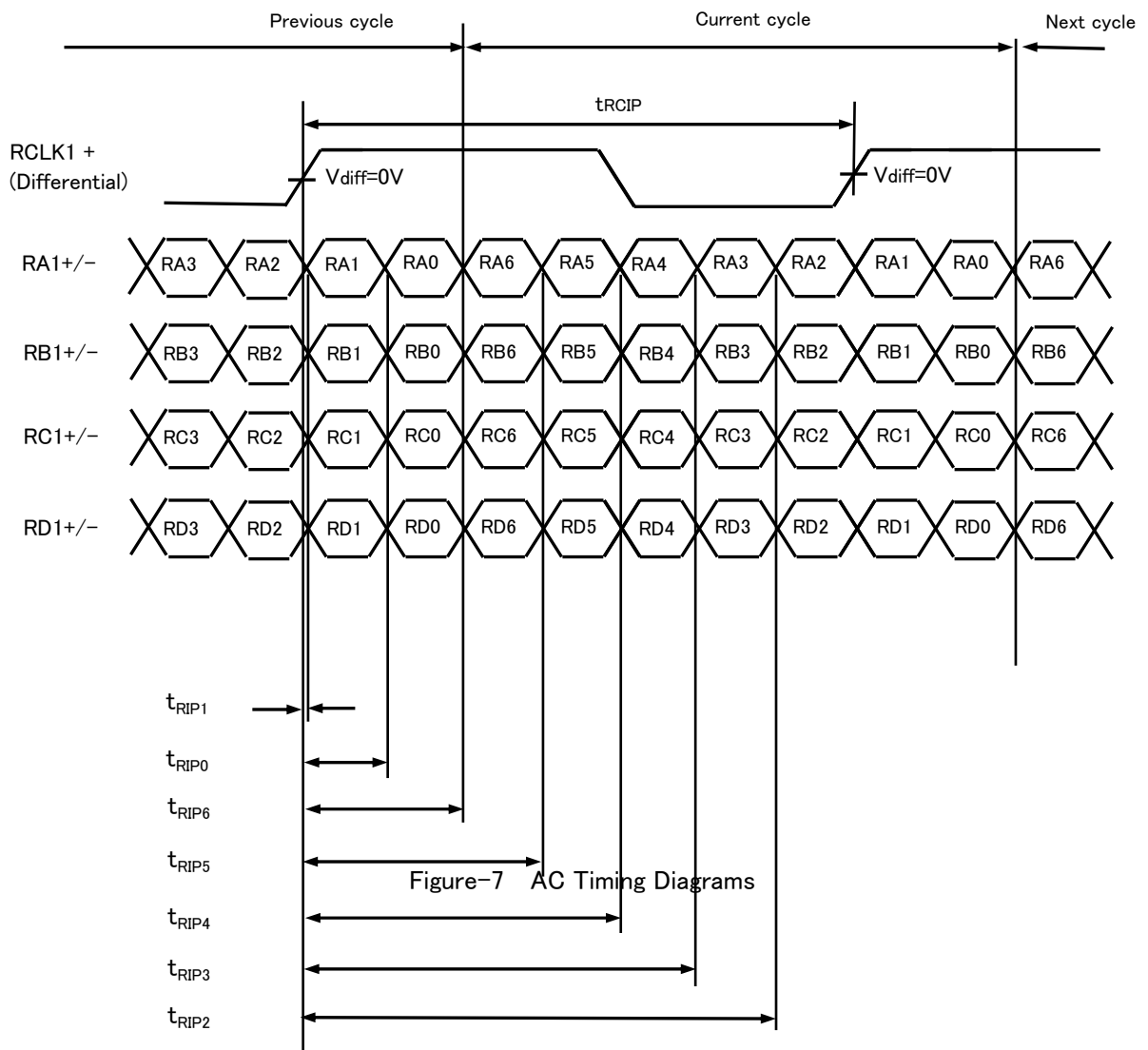
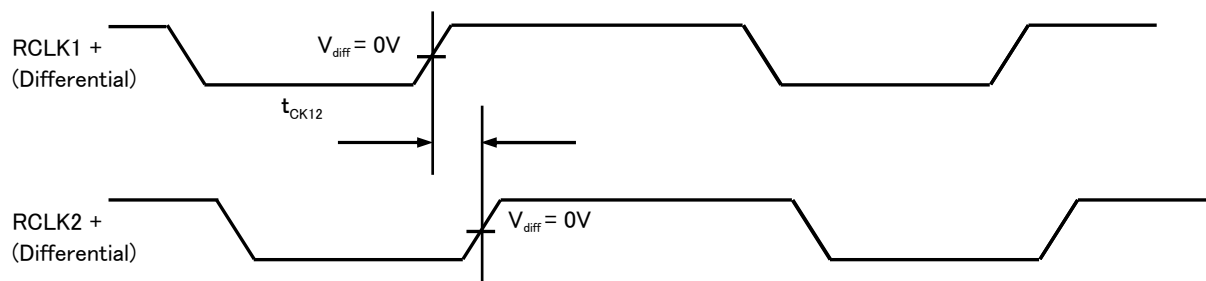


Figure-8 LVDS data and clock input timing



Note : $V_{diff} = (R_{yx+}) - (R_{yx-}), (RCLKx+) - (RCLKx-),$

●LVDS Data, Clock Input and Output Timing

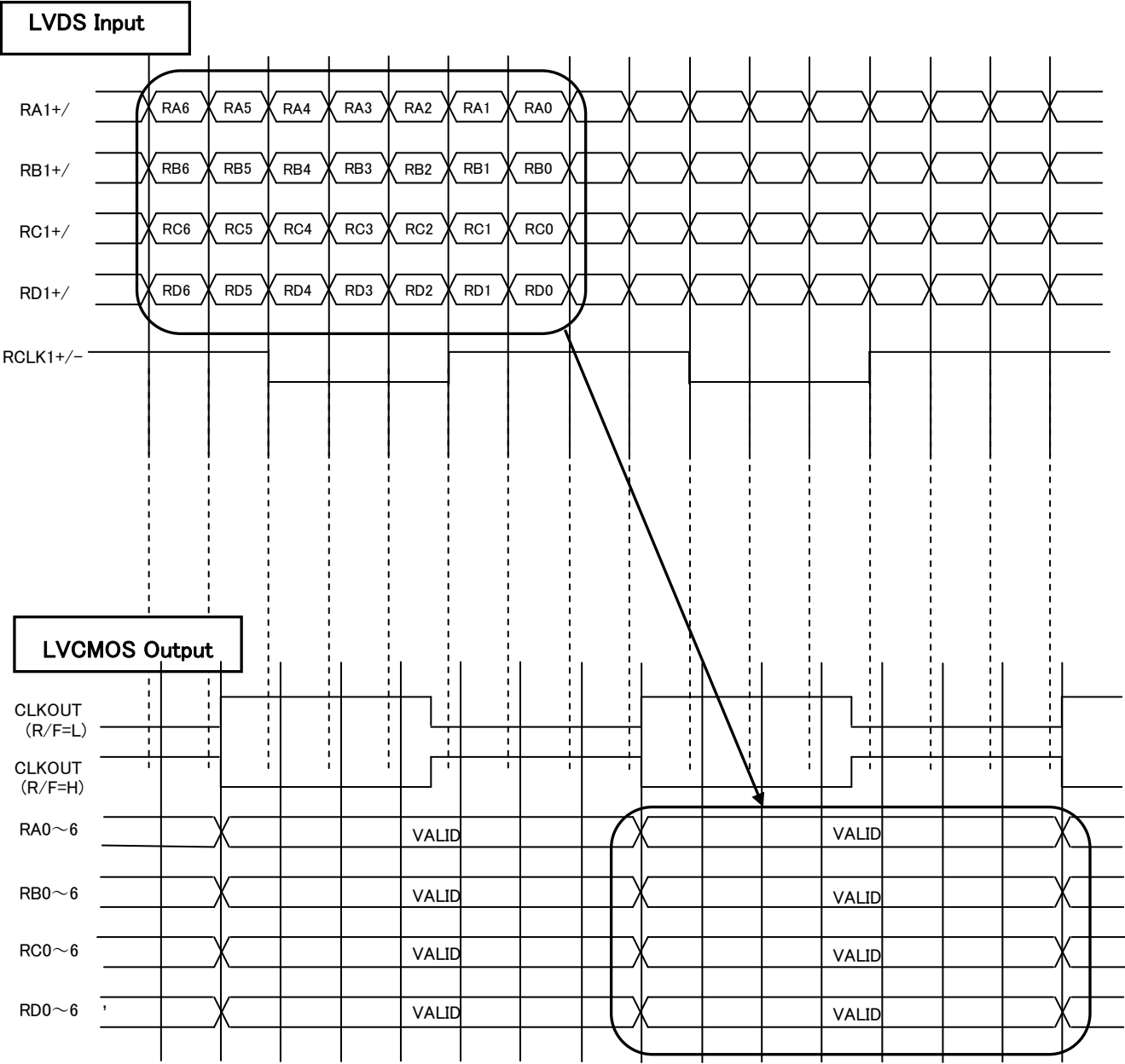


Figure-9 LVDS Data, Clock Input and Output Timing

● Pixel Map Table for Dual Link

Table 9: Pixel Map

1st Pixel Data				2nd Pixel Data			
TFT Panel Data			BU7985KVT LVCMOS Output Pin	TFT Panel Data			BU7985KVT LVCMOS Output Pin
	24Bit	18Bit			24Bit	18Bit	
LSB	R10	–	R10	LSB	R20	–	R20
	R11	–	R11		R21	–	R21
	R12	R10	R12		R22	R20	R22
	R13	R11	R13		R23	R21	R23
	R14	R12	R14		R24	R22	R24
	R15	R13	R15		R25	R23	R25
	R16	R14	R16		R26	R24	R26
MSB	R17	R15	R17	MSB	R27	R25	R27
LSB	G10	–	G10	LSB	G20	–	G20
	G11	–	G11		G21	–	G21
	G12	G10	G12		G22	G20	G22
	G13	G11	G13		G23	G21	G23
	G14	G12	G14		G24	G22	G24
	G15	G13	G15		G25	G23	G25
	G16	G14	G16		G26	G24	G26
MSB	G17	G15	G17	MSB	G27	G25	G27
LSB	B10	–	B10	LSB	B20	–	B20
	B11	–	B11		B21	–	B21
	B12	B10	B12		B22	B20	B22
	B13	B11	B13		B23	B21	B23
	B14	B12	B14		B24	B22	B24
	B15	B13	B15		B25	B23	B25
	B16	B14	B16		B26	B24	B26
MSB	B17	B15	B17	MSB	B27	B25	B27
	HSYNC	HSYNC	HSYNC		HSYNC	HSYNC	HSYNC
	VSYNC	VSYNC	VSYNC		VSYNC	VSYNC	VSYNC
	DE	DE	DE		DE	DE	DE

● CMOS Data Output Timing for Dual Link

Example : SXGA+(1400 × 1050)

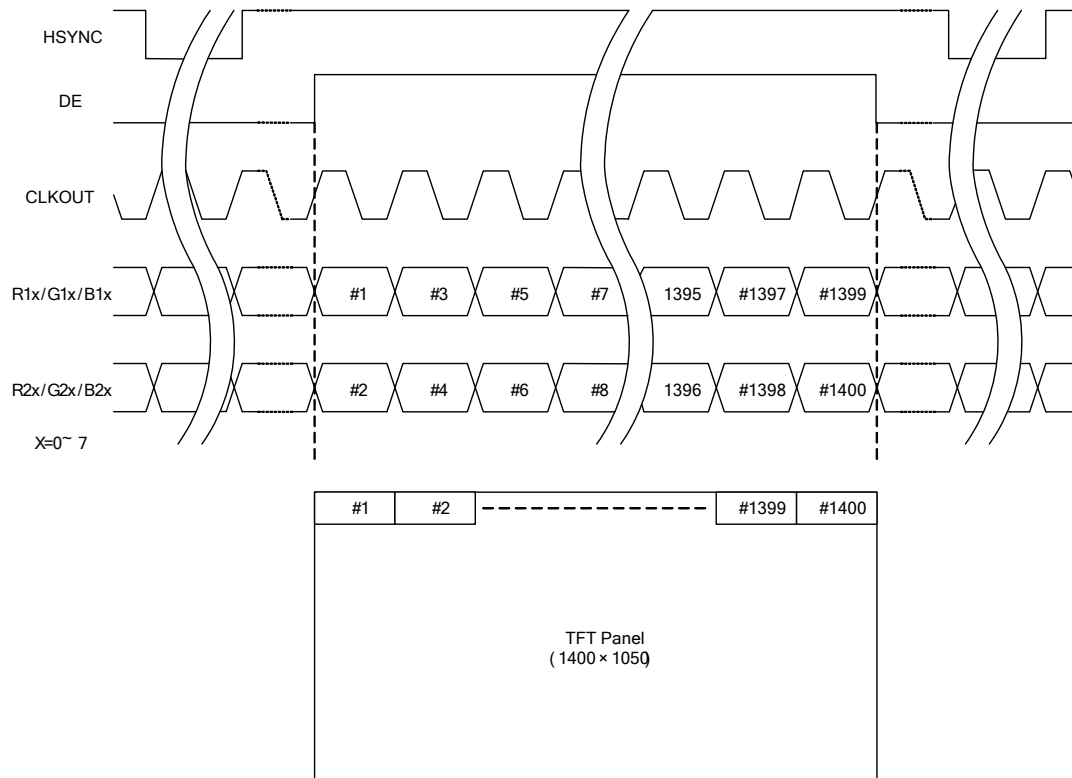


Figure-10 Data Output Timing for Dual Link

● CMOS Data Output Timing for Single Link

Example : SXGA+(1400 × 1050)

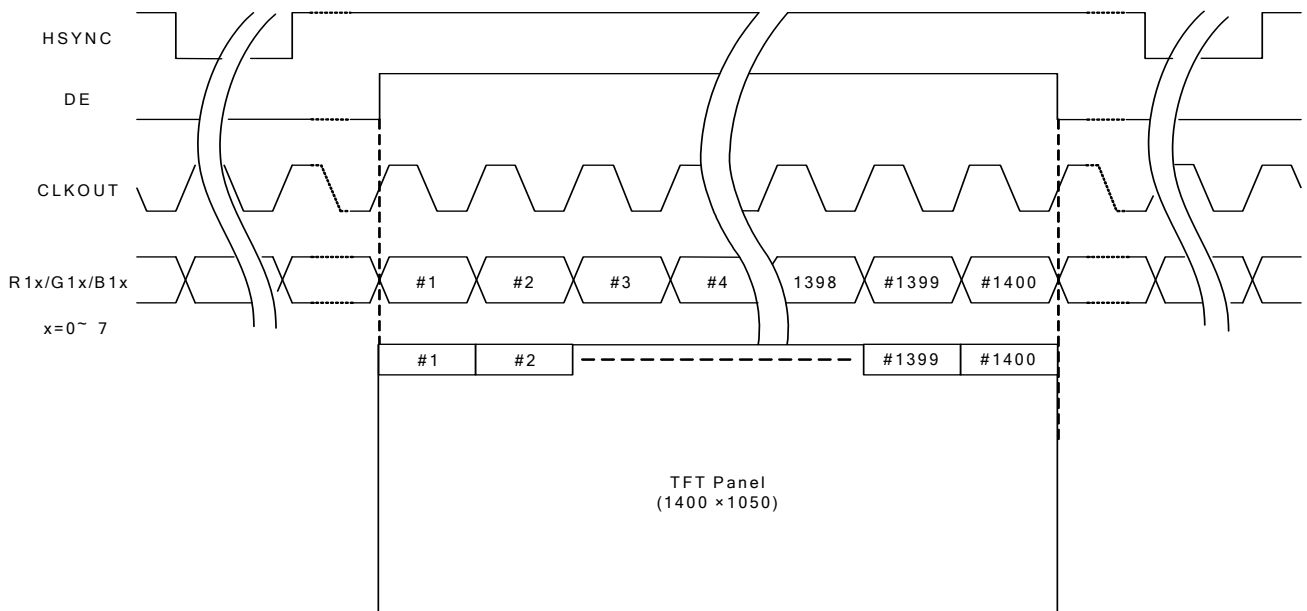


Figure-11 Data Output Timing for Dual Link

● LVDS Data Inputs Timing Diagrams in Dual Link
(Dual-in / Dual-out Mode)

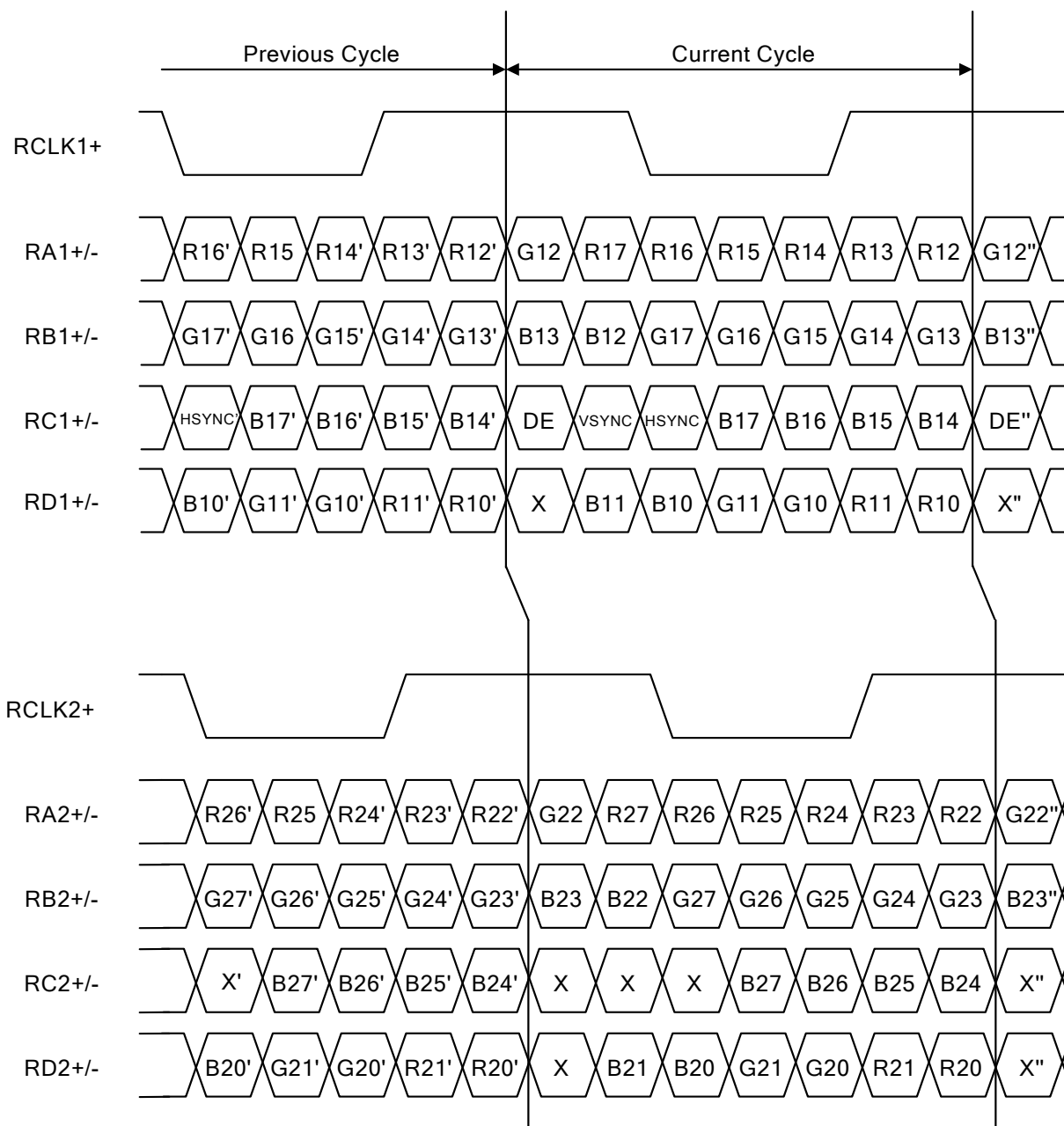


Figure-12 Data Input Timing for Dual Link

● LVDS Data Inputs Timing Diagrams in Single Link (Single-in / Dual-out Mode)

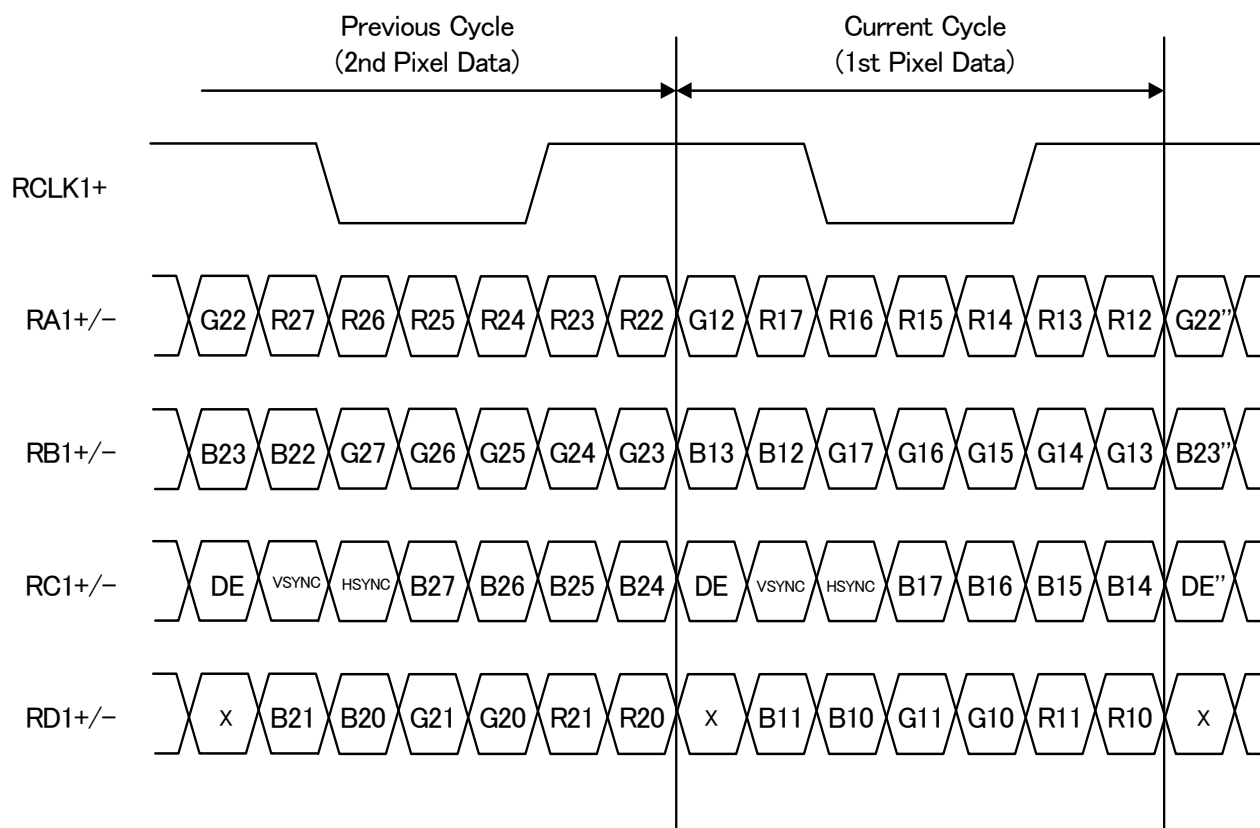


Figure-13 Data Input Timing for Single Link

● Fail-Safe Hi-Z Operation

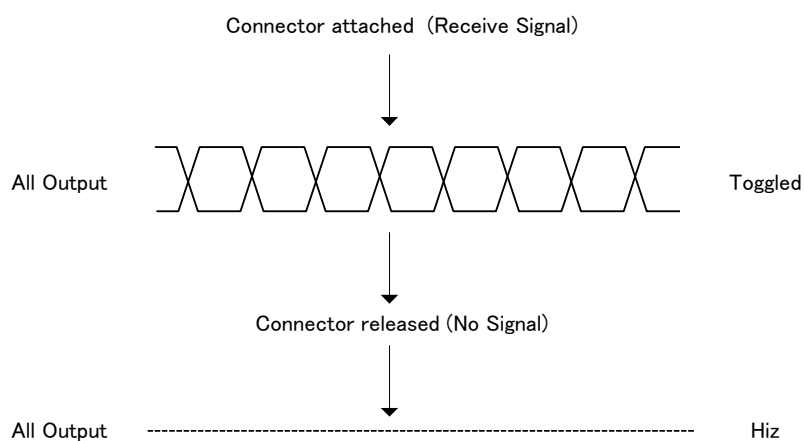


Figure-14 Fail-Sage Hi-Z Operation

●About the Power On Reset

Power On Reset is not mandatory for this device.

(The PD pin should be set to high level when Power On Reset procedure is not used.)

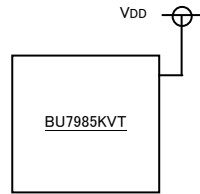


Figure-9 Terminal connection when Power On Reset is not used

However, Power On Reset procedure is strongly recommend for internal logic initialization by following two methods.

- ① The method of using CR circuit.
- ② The method of using external specific IC.

It is recommend to do enough examination for target application.

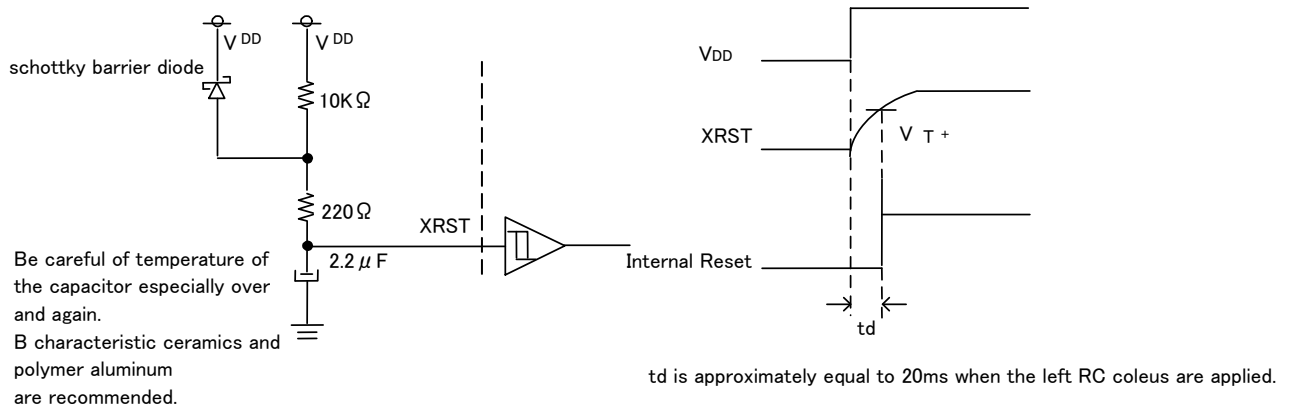


Figure-15 Power On Reset by external a CR circuit

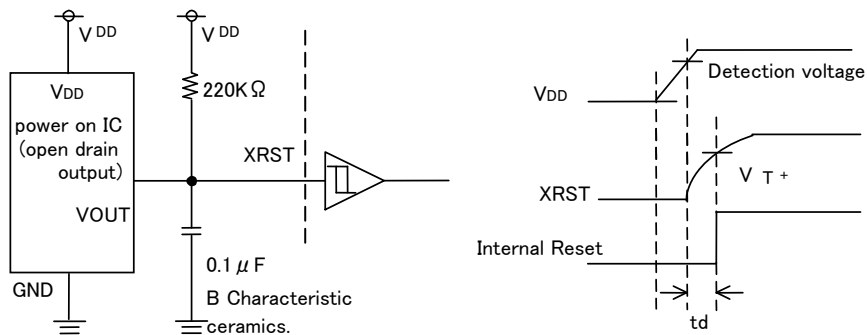


Figure-16 Power On Reset by specific IC

TOFP100V

<Dimension>

(Unit:mm)

<Packing information>

Container	Tray(with dry pack)
Quantity	500pcs
Direction of feed	Direction of product is fixed in a tray.

※When you order , please order in times the amount of package quantity.

- The contents described herein are correct as of June, 2008
- The contents described herein are subject to change without notice. For updates of the latest information, please contact and confirm with ROHM CO.,LTD.
- Any part of this application note must not be duplicated or copied without our permission.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams and information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by ROHM CO., LTD. is granted to any such buyer.
- The products described herein utilize silicon as the main material.
- The products described herein are not designed to be X ray proof.

The products listed in this catalog are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys). Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

Excellence in Electronics

ROHM

ROHM CO., LTD.

21, Saiin Mizosaki-cho, Ukyo-ku, Kyoto
 615-8585, Japan
 TEL: +81-75-311-2121 FAX: +81-75-315-0172
 URL [http:// www. rohm. com](http://www.rohm.com)

Published by

LSI Business Promotion Dept.

San Diego

Atlanta

Boston

Chicago

Dallas

Denver

Detroit

Nashville

Mexico

Düsseldorf

Munich

Stuttgart

France

United Kingdom

Denmark

Barcelona

Hungary

Poland

Russia

Seoul

Masan

Dalian

Beijing

Tianjin

TEL: +1-858-625-3630

TEL: +1-770-754-5972

TEL: +1-978-371-0382

TEL: +1-847-368-1006

TEL: +1-469-287-5366

TEL: +1-303-708-0908

TEL: +1-248-348-9920

TEL: +1-615-620-6700

TEL: +52-33-3123-2001

TEL: +49-2154-9210

TEL: +49-8161-48310

TEL: +49-711-72723710

TEL: +33-1-5697-3060

TEL: +44-1-908-306700

TEL: +45-3694-4739

TEL: +34-9375-24320

TEL: +36-1-4719338

TEL: +48-22-5757213

TEL: +7-95-980-6755

TEL: +82-2-8182-700

TEL: +82-55-240-6234

TEL: +86-411-8230-8549

TEL: +86-10-8525-2483

TEL: +86-22-23029181

FAX: +1-858-625-3670

FAX: +1-770-754-0691

FAX: +1-928-438-7164

FAX: +1-847-368-1008

FAX: +1-469-362-7973

FAX: +1-303-708-0858

FAX: +1-248-348-9942

FAX: +1-615-620-6702

FAX: +52-33-3123-2002

FAX: +49-2154-921400

FAX: +49-8161-483120

FAX: +49-711-72723720

FAX: +33-1-5697-3080

FAX: +44-1-908-235788

FAX: +45-3694-4789

FAX: +34-9375-24410

FAX: +36-1-4719339

FAX: +48-22-5757001

FAX: +7-95-937-8290

FAX: +82-2-8182-715

FAX: +82-55-240-6236

FAX: +86-411-8230-8537

FAX: +86-10-8525-2489

FAX: +86-22-23029183

Shanghai

Hangzhou

Nanjing

Ningbo

Qingdao

Suzhou

Wuxi

Shenzhen

Dongguan

Fuzhou

Guangzhou

Huizhou

Xiamen

Zhuhai

Hong Kong

Taipei

Kaohsiung

Singapore

Philippines

Thailand

Kuala Lumpur

Penang

Kyoto

Yokohama

TEL: +86-21-6279-2727

TEL: +86-571-87658072

TEL: +86-25-8689-0015

TEL: +86-574-87654201

TEL: +86-532-5779-312

TEL: +86-512-6807-1300

TEL: +86-510-82702693

TEL: +86-755-8307-3008

TEL: +86-769-8393-3320

TEL: +86-591-8801-8698

TEL: +86-20-8364-9796

TEL: +86-752-205-1054

TEL: +86-592-238-5705

TEL: +86-756-3232-480

TEL: +852-2-740-6262

TEL: +886-7-237-0881

TEL: +886-2-2500-6956

TEL: +65-6332-2322

TEL: +63-2-807-6872

TEL: +66-2-254-4890

TEL: +60-3-7958-8355

TEL: +60-4-2286453

TEL: +81-75-365-1218

TEL: +81-45-476-2290

FAX: +86-21-6247-2066

FAX: +86-571-87658071

FAX: +86-25-8689-0393

FAX: +86-574-87654208

FAX: +86-532-5779-653

FAX: +86-512-6807-2300

FAX: +86-510-82702992

FAX: +86-755-8307-3003

FAX: +86-769-8398-4140

FAX: +86-591-8801-8690

FAX: +86-20-8364-9707

FAX: +86-752-205-1059

FAX: +86-592-239-8380

FAX: +86-756-3232-460

FAX: +852-2-375-8971

FAX: +886-7-238-7332

FAX: +886-2-2503-2869

FAX: +886-7-238-7332

FAX: +65-6332-5662

FAX: +63-2-809-1422

FAX: +66-2-256-6334

FAX: +60-3-7958-8377

FAX: +60-4-2286452

FAX: +81-75-365-1228

FAX: +81-45-476-2295

Contact us for further information about the products.

Catalog No.08T242A '08.6 ROHM ©



**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331